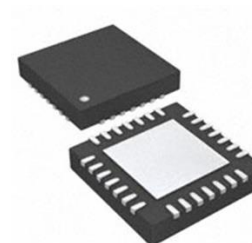


Three Phase Brushless Motor Pre-Driver

PRODUCT DESCRIPTION

The MS4931 is a three-phase brushless motor pre-driver chip, up to 35V operating voltage, can drive a wide range of N-channel power MOSFETs.

The chip has functions of stall guard, over temperature protection, and synchronous rectification. Internal synchronization allows the chip to reduce power consumption by turning on the appropriate power MOSFETs during current decay. The chip has enable, direction, and brake inputs to control current, FG1 and FG2 outputs to control motor rotation.



QFN28

FEATURES

- Drive 6 N-type Power MOSFETs
- Synchronous Rectifier, Shutdown Mode, Low Power
- Low Voltage Protection, Over Temperature Protection
- Hall Elements Input or Hall Ic Input
- PWM Control Current, Positive and Reverse Rotation Model
- FG1 and FG2 Output
- 5V LDO Out
- Stall Guard Protection
- QFN28 Package

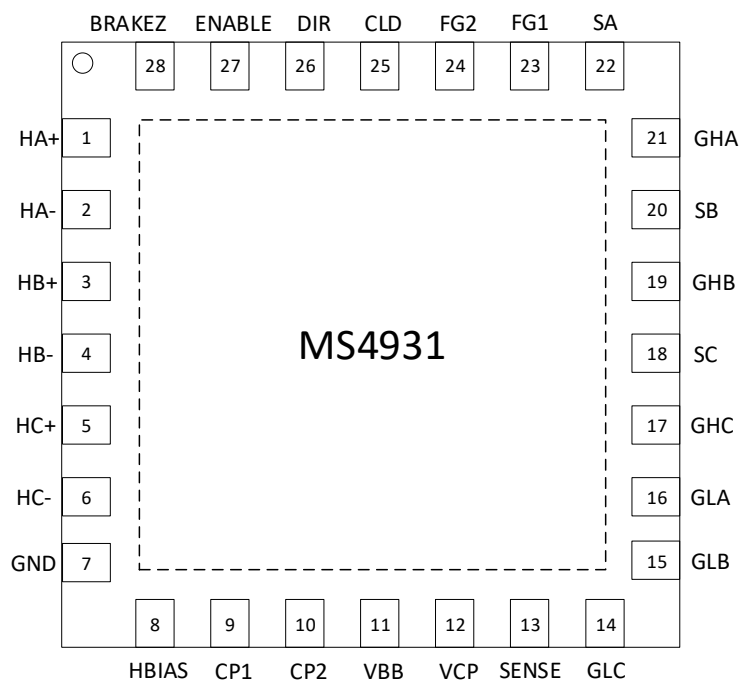
APPLICATIONS

- Laser Printer, Copier
- Power Rotate Tools
- Water Pump, Gas Pump
- Monitoring Camera

PRODUCT SPECIFICATION

Part Number	Package	Marking
MS4931	QFN28	MS4931

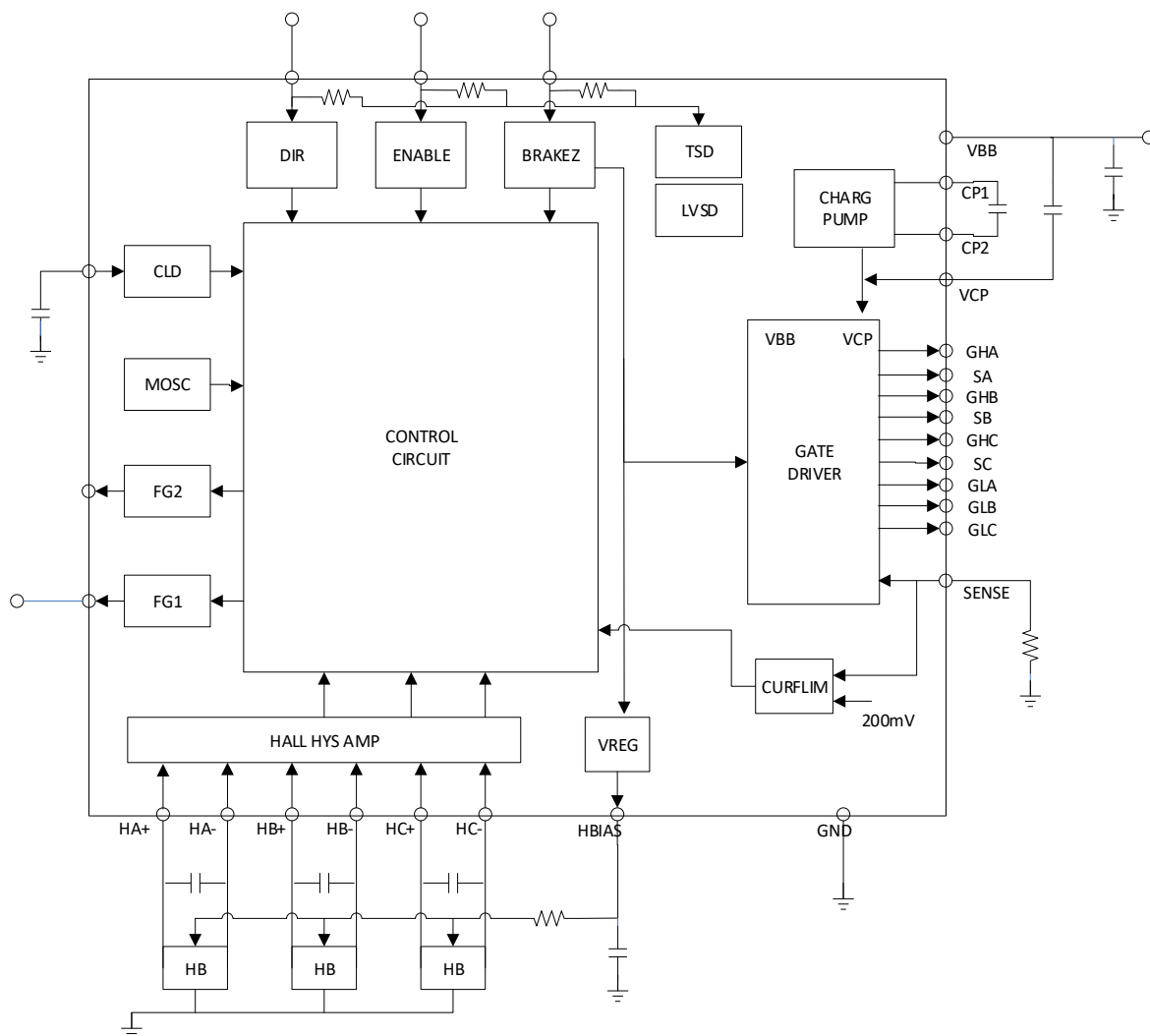
PIN CONFIGURATION



PIN DESCRIPTION

Pin	Name	Type	Description
1	HA+	I	HALL Input H: IN+>IN-; L: IN->IN+
2	HA-		
3	HB+		
4	HB-		
5	HC+		
6	HC-		
7	GND	-	Ground
8	HBIAS	O	5V LDO Out
9	CP1	O	Charge-pump Capacitor
10	CP2		
11	VBB	-	Power
12	VCP	I/O	Charge-pump Output
13	SENSE	O	Current Sense Pin
14	GLC	O	H-bridge Low Side Output C
15	GLB		H-bridge Low Side Output B
16	GLA		H-bridge Low Side Output A
17	GHC		H-bridge High Side Output C
18	SC		Output C
19	GHB		H-bridge High Side Output B
20	SB		Output B
21	GHA		H-bridge High Side Output A
22	SA		Output A
23	FG1	O	Hall Output (3 ϕ)
24	FG2	O	Hall Output (1 ϕ)
25	CLD	I/O	Stall Guard Capacitor
26	DIR	I	Rotate Direction
27	ENABLE	I	PWM Speed Control
28	BRAKEZ	I	Motor Brake 0: Brake 1 or Open: Active

BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Any exceeding absolute maximum rating application causes permanent damage to device. Because long-time absolute operation state affects device reliability. Absolute ratings just conclude from a series of extreme tests. It doesn't represent chip can operate normally in these extreme conditions.

Parameter	Symbol	Range	Unit
Supply Voltage	V_{BBMAX}	35	V
Charge-pump Voltage	V_{CPMAX}	42	V
Junction Temperature	T_{JMAX}	150	°C
Operating Temperature Range	T_A	-40 ~ 105	°C
Store Temperature Range	T_{STG}	-65 ~ 150	°C
Thermal Resistance	$R_{\theta JA}$	43	°C/W

ELECTRICAL CHARACTERISTICS

$T_A = 25^{\circ}\text{C}$, $V_{BB}=24\text{V}$, unless otherwise noted.

Pin Parameters

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage	V_{BB}		8.0		35	V
HBIAS Pin Current	I_{REG}		0		-200	mA
FG Voltage	V_{FG}		0		6	V
FG Current	I_{FG}		0		14	mA

Electrical Characteristics

Parameter	Symbol	Condition	Min	Typ	Max	Unit
Supply Current 1	I_{CC1}			3.8	4.7	mA
Supply Current 2	I_{CC2}	Output Disable		0.89	1.1	mA

Output Driver

High Side Gate Drive Voltage	$V_{GS(H)}$	$I_{GATE}=2\text{mA}$		5.2		V
Low Side Gate Drive Voltage	$V_{GS(L)}$	$I_{GATE}=2\text{mA}$		5.6		V
Gate Drive Current	I_{GATE}	$G_H=G_L=4$	20	30		mA
Gate Drive Pull Down Resistor	R_{GATE}			30		Ω
Dead Time	t_{DEAD}	$I_D=-1\text{A}$		1.2		μs
Current Limit Threshold Voltage	V_{REF}	$I_D=1\text{A}$, $R_{SENSE}=0.2\Omega$		200		mV

5V HBIAS

HBIAS Output Voltage	V_{HBIAS}	$I_O=-5\text{mA}$	5.5	5.6	5.7	V
Line Regulation	$\Delta V_{(REG1)}$	$V_{BB}=8$ to 35V , $I_O=-5\text{mA}$			7	mV
Load Regulation	$\Delta V_{(REG2)}$	$I_O=-5\text{mA}$ to -10mA			0.4	mV

HALL Amplifier

Input Current	$I_{B(HA)}$		-130			nA
Common Mode Input Range	V_{ICM2}	When use hall IC	0		V_{HBIAS}	V
Hall Input Range	V_{HIN}	Sine wave input	80			mVp-p
Hall Input Hysteresis	$\Delta V_{IN(HA)}$			20		mV
Hall Input Threshold Up	V_{SLH}			8		mV
Hall Input Threshold Down	V_{SHL}			-12		mV

Parameter	Symbol	Condition	Min	Typ	Max	Unit
CLD Oscillator						
CLD High Level	$V_{OH(CL D)}$			3.07		V
CLD Low Level	$V_{OL(CL D)}$			1.08		V
Amplitude	$V_{(CL D)}$			2.0		V _{p-p}
External Capacitor Charge Current	$I_{CHG1(CL D)}$	$V_{CHG1}=2V$		-11.3		μA
External Capacitor Discharge Current	$I_{CHG2(CL D)}$	$V_{CHG2}=2V$		11.3		μA
Oscillator Frequency	$f_{(CL D)}$	$C=0.022\mu F$		129		Hz
Charge-pump (VCP Pin)						
VCP Voltage	V_{CPOUT}			$V_{BB}+5.2$		V
CP1 Pin						
On-Resistance (High-side)	$V_{OH(CP1)}$	$I_{CP1}=-2mA$		500	700	Ω
On-Resistance (Low-side)	$V_{OL(CP1)}$	$I_{CP1}=2mA$		350	500	Ω
Pump Frequency	$f_{(CP)}$		42	50	70	kHz
Internal PWM						
Oscillation Frequency	$f_{(PWM)}$		41	51.5	62	kHz
Current Limit						
Limit Voltage	V_{RF}			0.2		V
Blank Time	t_{BLANK}			1.2		μs
Over Temperature Protection						
Shutdown Temperature	T_{SD}	Junction temperature	146	154	158	°C
Hysteresis Width	ΔT_{SD}	Junction temperature	20	30	40	°C
Low Voltage Protection (5V HBIAS)						
Operation Voltage	V_{SD}		4.0	4.17	4.4	V
Hysteresis Width	ΔV_{SD}		0.29	0.30	0.31	V
FG Pin/FG2 Pin						
On-resistance	$V_{OL(FG)}$	$I_{FG}=5mA$		17	20	Ω
Leakage Current	$I_{L(FG)}$	$V_O=5V$			10	μA
BRAKEZ Pin						
High-level Input Voltage	$V_{IH(BRAKEZ)}$		1.75		V_{HBIAS}	V
Low-level Input Voltage	$V_{IL(BRAKEZ)}$		0		1..65	V
Open-drain Input Voltage	$V_{IO(BRAKEZ)}$			$3/5 \times V_{HBIAS}$		V
Hysteresis Width	$V_{IS(BRAKEZ)}$		0.3	0.4	0.5	V
High-Level Input Current	$I_{IH(BRAKEZ)}$	$V_{BRAKEZ}=V_{HBIAS}$	41	51	65	μA
Low-Level Input Current	$I_{IL(BRAKEZ)}$	$V_{BRAKEZ}=0V$	-65	-76	-95	μA

Parameter	Symbol	Condition	Min	Typ	Max	Unit
ENABLE Pin						
Recommended Input Frequency	$f_{(ENABLE)}$		0.5		60	kHz
High-level Input Voltage	$V_{IH(ENABLE)}$		1.75		V_{HBIAS}	V
Low-level Input Voltage	$V_{IL(ENABLE)}$		0		1.65	V
Open-drain Input Voltage	$V_{IO(ENABLE)}$			$3/5 \times V_{HBIAS}$		V
Hysteresis Width	$V_{IS(ENABLE)}$		0.3	0.4	0.5	V
High-Level Input Current	$I_{IH(ENABLE)}$	$V_{ENABLE}=V_{HBIAS}$	41	51	65	μA
Low-Level Input Current	$I_{IL(ENABLE)}$	$V_{ENABLE}=0V$	-65	-76	-95	μA
DIR Pin						
High-level Input Voltage	$V_{IH(DIR)}$		1.75		V_{HBIAS}	V
Low-level Input Voltage	$V_{IL(DIR)}$		0		1.65	V
Open-drain Input Voltage	$V_{IO(DIR)}$			$3/5 \times V_{HBIAS}$		V
Hysteresis Width	$V_{IS(DIR)}$		0.3	0.4	0.5	V
High-Level Input Current	$I_{IH(DIR)}$	$V_{DIR}=V_{HBIAS}$	41	51	65	μA
Low-Level Input Current	$I_{IL(DIR)}$	$V_{DIR}=0V$	-65	-76	-95	μA

Logic True Table

(IN="High" means $IN^+ > IN^-$), ("H"=SOURCE, "L"=SINK, "Z"=High-impedance)

HALL In						Pre-driver						Output		
DIR	HA	HB	HC	BRAKEZ	ENB	GHA	GLA	GHB	GLB	GHC	GLC	A	B	C
1	H	L	H	H	L	H	L	L	H	L	L	H	L	Z
	H	L	L	H	L	H	L	L	L	L	H	H	Z	L
	H	H	L	H	L	L	L	H	L	L	H	Z	H	L
	L	H	L	H	L	L	H	H	L	L	L	L	H	Z
	L	H	H	H	L	L	H	L	L	H	L	L	Z	H
	L	L	H	H	L	L	L	L	H	H	L	Z	L	H
0	H	L	H	H	L	L	H	H	L	L	L	L	H	Z
	L	L	H	H	L	L	L	H	L	L	H	Z	H	L
	L	H	H	H	L	H	L	L	L	L	H	H	Z	L

HALL In						Pre-driver						Output		
DIR	HA	HB	HC	BRAKEZ	ENB	GHA	GLA	GHB	GLB	GHC	GLC	A	B	C
0	L	H	L	H	L	H	L	L	H	L	L	H	L	Z
	H	H	L	H	L	L	L	L	H	H	L	Z	L	H
	H	L	L	H	L	L	H	L	L	H	L	L	Z	H
X	H	H	H	H	X	L	L	L	L	L	L	Z	Z	Z
X	L	L	L	H	X	L	L	L	L	L	L	Z	Z	Z
X	X	X	X	L	X	L	H	L	H	L	H	L	L	L

FG

IN1	IN2	IN3	FG1	FG2
H	L	H	H	H
H	L	L	L	H
H	H	L	H	H
L	H	L	L	L
L	H	H	H	L
L	L	H	L	L

BRAKEZ,ENABLE

Input	BRAKEZ	ENABLE
High or Open	Active	Output Off
Low	Stop(Short Brake)	Output On

CLD Function

BRAKEZ Set High	—>	Protection Released and Count Reset(Initial Reset)
DIR Switched	—>	Protection Released and Count Reset
ENABLE 0% Duty	—>	Protection Released and Count Reset
Low Voltage Protection	—>	Protection Released and Count Reset(Initial Reset)
Over Temperature Protection	—>	Stop Counting

FUNCTION DESCRIPTION

Output Drive Circuit

The chip adopts a direct PWM drive method to reduce power. It regulates the drive force of the motor by changing the duty of output. The output PWM switching is performed by the upper-side output transistor. This IC performs synchronous rectification, and is intended to reduce heat generation compared to diode regeneration.

Current Limiter Circuit

The current limiter circuit limits the output current peak value to a level determined by the equation $I = V_{RF}/R_f$ ($V_{RF} = 0.20V$ (typical), R_f : current detection resistor). This circuit suppresses the output current by reducing the duty of output.

The current limiter circuit has an operation delay (approx. $1.2\mu s$) to detect reverse recovery current flowing in the diode due to the PWM operation, and prevent a malfunction of the current limiting operation. If the coil resistance of the motor is small, or the inductance is low, the current at startup (the state in which there is no back electromotive force generated in the motor) will change rapidly. As a result, the operation delay may sometimes cause the current limiting operation to take place when a value is above the set current. In such a case, it is necessary to set the current limit value while taking into consideration the increase in current due to the delay.

The PWM frequency in the current limiter circuit is determined by the internal reference oscillator, and is approximately 50kHz.

Speed Control Method

Pulses are input to the ENABLE pin, and the output can be controlled by varying the duty cycle of these pulses.

When a low-level input voltage is applied to ENABLE pin, the output at the PWM side (upper side) is set to ON.

When a high-level input voltage is applied to ENABLE pin, the output at the PWM side (upper side) is set to OFF.

If it is necessary to input pulses using inverted logic, this can be done by adding an external transistor (NPN).

When the input to the ENABLE pin remains high-level for a certain period, the IC judges that the duty is 0%, causing the CSD circuit count to be reset.

Constraint Protection Circuit

The MS4931 includes a constraint protection circuit for protecting the IC and the motor in a motor constraint mode. This circuit operates when the motor is in an operation condition and the Hall signal does not switch over for a certain period. Note that while this constraint protection is operating, the upper-side output transistor will be OFF.

Time setting is performed according to the capacitance of the capacitor connected to the CLD pin.

Set time (s) $\approx 90 \times C$ (μF)

When a $0.022\mu F$ capacitor is connected, the protection time becomes approximately 2.0 seconds. The set time must be selected to a value that provides adequate margin with respect to the motor startup time.

Conditions for releasing the constraint protection state:

- When the BRAKEZ pin is in a STOP state → Protection released and count reset (Initial reset)
- When the DIR pin is switched → Protection released and count reset
- When 0% duty is detected at the PWMIN pin input → Protection released and count reset

- When low-voltage condition is detected → Protection released and count reset (Initial reset)
- When TSD condition is detected → Stop counting

The CLD pin also functions as the initial reset pulse generation pin. If it is connected to ground, the logic circuit will go into a reset state, preventing speed control from taking place. Consequently, when not using constraint protection, connect a resistor of approximately 220kΩ and a capacitor of about 4700pF in parallel to ground.

Low Voltage Protection Circuit

The MS4931 incorporates a comparator that uses the band gap voltage as the reference. The circuit monitors the voltage at the HBIAS pin (5.6V). When the BRAKEZ pin is low and the voltage at the HBIAS pin falls below 4.15V (typ.), the protection circuit is activated. Thus all output transistors are set to OFF.

Thermal Shutdown Circuit

When the IC junction temperature exceeds 154°C (design target value), the thermal shutdown circuit is activated, and all the output transistors are set to OFF.

Hall Input Signal

A pulse input with the amplitude in excess of the hysteresis (35mV maximum) is required for the Hall inputs.

It is desirable that the amplitude of the Hall input signal be 100mVp-p or more in consideration of the effect of noise and phase displacement.

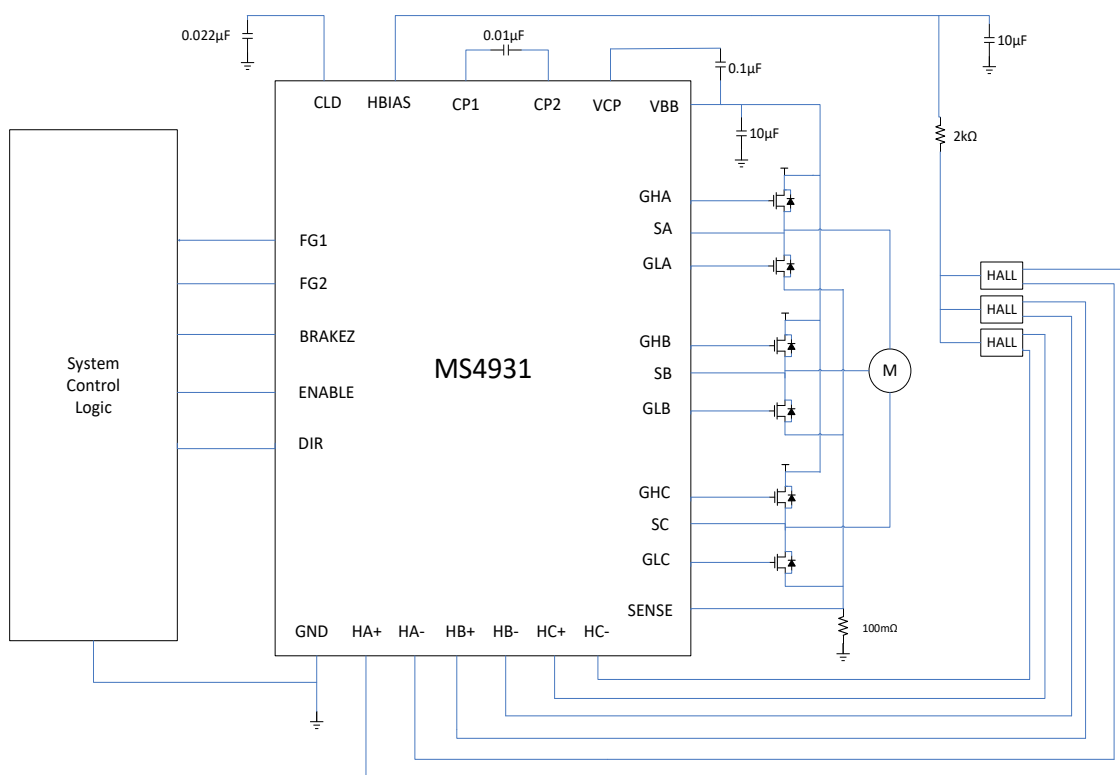
Charge-pump

The charge-pump is used to generate a gate supply greater than the VBB in order to drive the source-side DMOS gates.

A 0.01μF ceramic capacitor should be connected between CP1 and CP2 for pumping purposes.

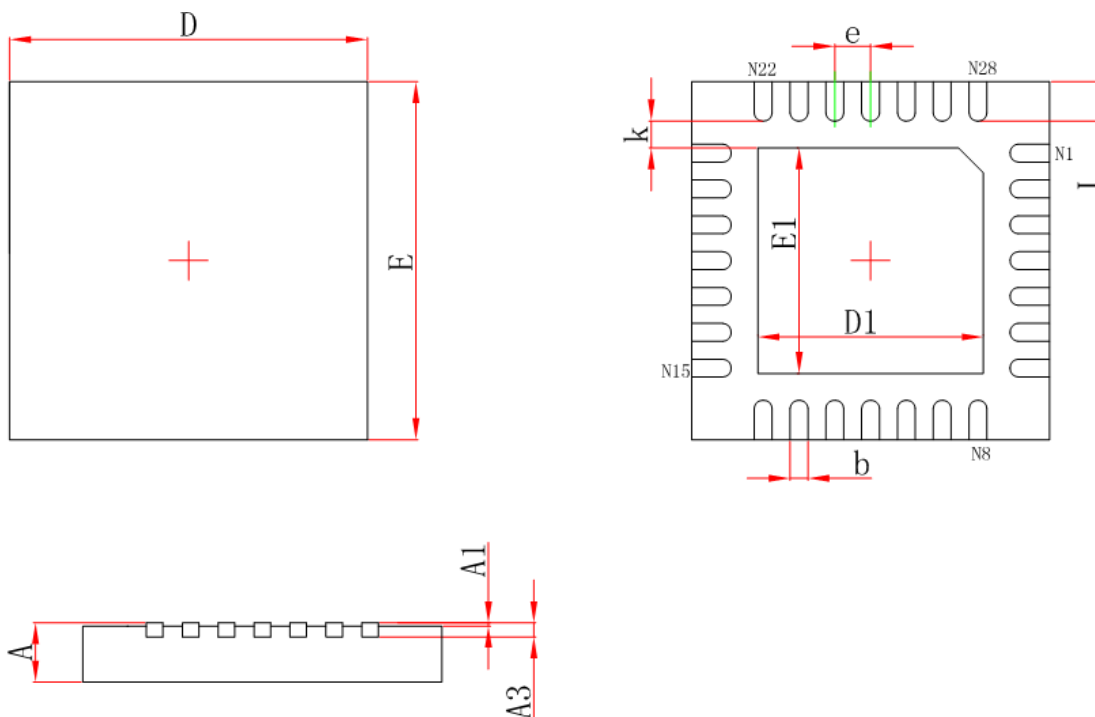
A 0.1μF ceramic capacitor is required between VCP and VBB to act as a reservoir to operate the high-side DMOS devices.

TYPICAL APPLICATION DIAGRAM



PACKAGE OUTLINE DIMENSIONS

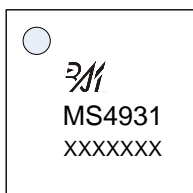
QFN28



Symbol	Dimensions in Millimeters		Dimensions in Inches	
	Min	Max	Min	Max
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.001	0.002
A3	0.203REF		0.008REF	
b	0.180	0.300	0.007	0.012
D	4.900	5.100	0.193	0.201
E	4.900	5.100	0.193	0.201
D1	3.050	3.250	0.120	0.128
E1	3.050	3.250	0.120	0.128
e	0.500TYP		0.020TYP	
L	0.450	0.650	0.018	0.026
k	0.200MIN		0.008MIN	

MARKING and PACKAGING SPECIFICATION

1. Marking Drawing Description



Product Name: MS4931

Product Code: XXXXXXX

2. Marking Drawing Demand

Laser printing, contents in the middle, font type Arial.

3. Packaging Specification

Device	Package	Piece/Reel	Reel/Box	Piece/Box	Box/Carton	Piece/Carton
MS4931	QFN28	1000	8	8000	4	32000

STATEMENT

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- The process of improving product is endless. And our company would sincerely provide more excellent product for customer.

**MOS CIRCUIT OPERATION PRECAUTIONS**

Static electricity can be generated in many places. The following precautions can be taken to effectively prevent the damage of MOS circuit caused by electrostatic discharge:

1. The operator shall ground through the anti-static wristband.
2. The equipment shell must be grounded.
3. The tools used in the assembly process must be grounded.
4. Must use conductor packaging or anti-static materials packaging or transportation.



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